

# Inference

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("packag\$3andbond\$3near2pad\$1andencapsulat\$3anddielectricandbumpandchipandtrace\$1and(cavityorholeorvia)").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/01/12 16:48
L2	235826	packag\$3 and bond\$3 near2pad\$1 and encapsulat\$3 and dielectric and bump and chip and trace\$1 and (cavity or hole or via)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/01/12 16:50
L3	657	packag\$3 and bond\$3 near2 pad\$1 and encapsulat\$3 and dielectric and bump and chip and trace\$1 and (cavity or hole or via)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2007/01/12 16:50

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	376	packag\$3 and bond\$3 near2 pad\$1 and encapsulat\$3 and dielectric and bump and chip and trace\$1 and (cavity or hole or via)	USPAT; EPO; JPO; DERWENT	OR	OFF	2007/01/12 16:50